# onsemi

# **Switch Mode Power Rectifiers**

16 A, 35 and 45 V

# **MBR1635, MBR1645, MBRB1645, NRVBB1645**

These state-of-the-art devices use the Schottky Barrier principle with a platinum barrier metal.

## **Features**

- Guard-ring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### **Mechanical Characteristics:**

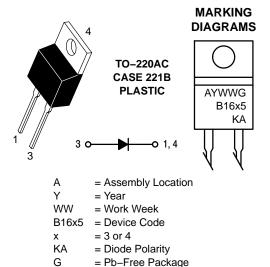
- Case: Epoxy, Molded
- Weight: 1.9 Grams for TO-220 1.7 Grams for D<sup>2</sup>PAK
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

#### MAXIMUM RATINGS

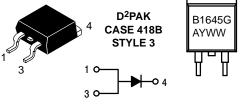
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBR1635 MBR1645 MBRB1645	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35 45 45	V
Average Rectified Forward Current Delay (Rated $V_R$ , $T_C$ = 163°C) Total Device	I <sub>F(AV)</sub>	16	A
Peak Repetitive Forward Current, Per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 157°C) Total Device	I <sub>FRM</sub>	32	A
Non–Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs

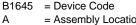
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

The heat generated must be less than the thermal conductivity from 1. Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .









= Assembly Location

= Year

ww = Work Week

G = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR1645G	TO–220 (Pb–Free)	50 Units / Rail

#### **DISCONTINUED** (Note 1)

Y

MBR1635G	TO-220 (Pb-Free)	50 Units / Rail
MBRB1645T4G	D <sup>2</sup> PAK (Pb–Free)	800 Units / Rail
NRVBB1645T4G	D <sup>2</sup> PAK (Pb–Free)	800 Units / Rail

1. DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

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# THERMAL CHARACTERISTICS

Characteristic		Symbol	Value	Unit
Maximum Thermal Resistance,	Junction-to-Case	$R_{ extsf{ heta}JC}$	1.5	°C/W

# **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 2) ( $i_F = 16 \text{ Amps}, T_C = 125^{\circ}C$ ) ( $i_F = 16 \text{ Amps}, T_C = 25^{\circ}C$ )	V <sub>F</sub>	0.57 0.63	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	İR	40 0.2	mA

2. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

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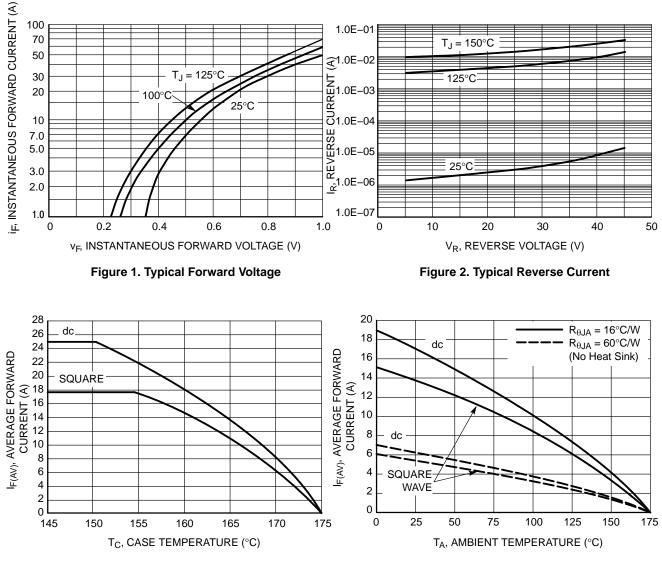


Figure 3. Current Derating, Case, Per Leg

Figure 4. Current Derating, Ambient

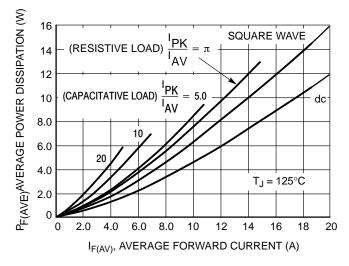
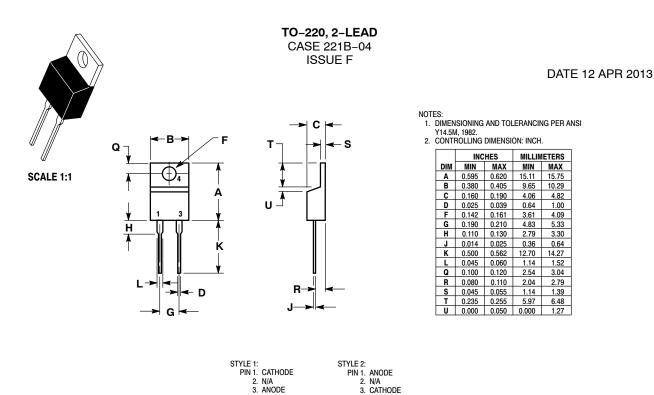


Figure 5. Forward Power Dissipation





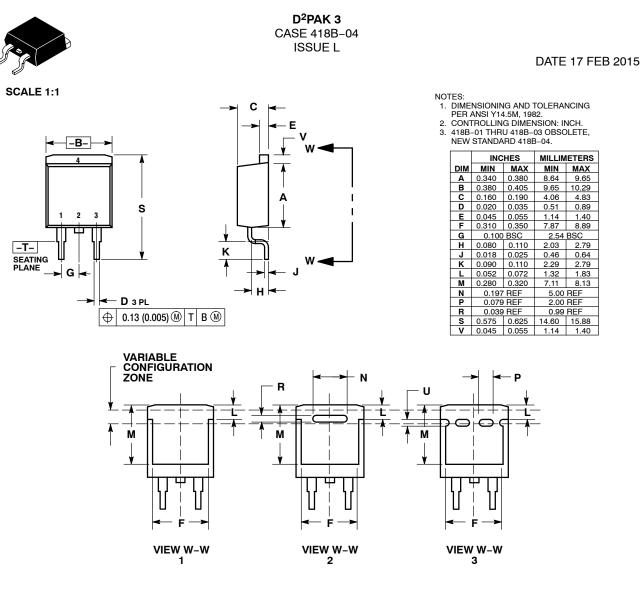
4. ANODE

4. CATHODE

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DESCRIPTION:	TO-220, 2-LEAD		PAGE 1 OF 1	

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STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE	PIN 1. CATHODE	PIN 1. NO CONNECT
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR	2. ANODE	2. CATHODE
3. EMITTER	<ol><li>SOURCE</li></ol>	<ol><li>ANODE</li></ol>	3. EMITTER	<ol><li>CATHODE</li></ol>	3. ANODE
4. COLLECTOR	4. DRAIN	4. CATHODE	4. COLLECTOR	4. ANODE	4. CATHODE

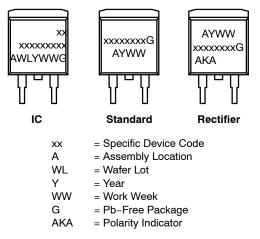
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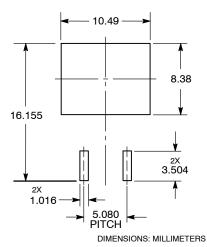
#### DATE 17 FEB 2015

#### GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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